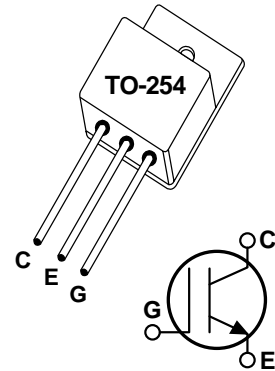


Thunderbolt IGBT[™]

The Thunderbolt IGBT[™] is a new generation of high voltage power IGBTs. Using Non-Punch Through Technology the Thunderbolt IGBT[™] offers superior ruggedness and ultrafast switching speed.

- Low Forward Voltage Drop
- Low Tail Current
- Avalanche Rated
- Hermetic Package
- High Freq. Switching to 150KHz
- Ultra Low Leakage Current
- RBSOA and SCSOA Rated




MAXIMUM RATINGS

All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	APT20GT60CR	UNIT
V_{CES}	Collector-Emitter Voltage	600	Volts
V_{CGR}	Collector-Gate Voltage ($R_{GE} = 20K\Omega$)	600	
V_{EC}	Emitter-Collector Voltage	15	
V_{GE}	Gate-Emitter Voltage	± 20	
I_{C1}	Continuous Collector Current ^④ @ $T_C = 25^\circ\text{C}$	25	Amps
I_{C2}	Continuous Collector Current @ $T_C = 85^\circ\text{C}$	20	
I_{CM}	Pulsed Collector Current ^① @ $T_C = 25^\circ\text{C}$	50	
I_{LM}	RBSOA Clamped Inductive Load Current @ $R_g = 11\Omega$ $T_C = 125^\circ\text{C}$	40	
E_{AS}	Single Pulse Avalanche Energy ^②	40	mJ
P_D	Total Power Dissipation	100	Watts
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	$^\circ\text{C}$
T_L	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{CES}	Collector-Emitter Breakdown Voltage ($V_{GE} = 0V, I_C = 0.5mA, T_j = -55^\circ\text{C}$)	600			Volts
RBV_{CES}	Collector-Emitter Reverse Breakdown Voltage ($V_{GE} = 0V, I_C = 50mA$)	-15			
$V_{GE(TH)}$	Gate Threshold Voltage ($V_{CE} = V_{GE}, I_C = 500\mu A, T_j = 25^\circ\text{C}$)	3	4	5	
$V_{CE(ON)}$	Collector-Emitter On Voltage ($V_{GE} = 15V, I_C = I_{C2}, T_j = 25^\circ\text{C}$)	1.6	2.0	2.5	
	Collector-Emitter On Voltage ($V_{GE} = 15V, I_C = I_{C2}, T_j = 150^\circ\text{C}$)			2.8	
I_{CES}	Collector Cut-off Current ($V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 25^\circ\text{C}$)			40	μA
	Collector Cut-off Current ($V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 150^\circ\text{C}$)			1000	
I_{GES}	Gate-Emitter Leakage Current ($V_{GE} = \pm 20V, V_{CE} = 0V$)			± 100	nA

 **CAUTION:** These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - <http://www.advancedpower.com>

USA 405 S.W. Columbia Street Bend, Oregon 97702-1035 Phone: (541) 382-8028 FAX: (541) 388-0364
 EUROPE Chemin de Magret F-33700 Merignac - France Phone: (33) 5 57 92 15 15 FAX: (33) 5 56 47 97 61

DYNAMIC CHARACTERISTICS
APT20GT60CR

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{ies}	Input Capacitance	Capacitance $V_{GE} = 0V$ $V_{CE} = 25V$ $f = 1\text{ MHz}$		1100		pF
C_{oes}	Output Capacitance			110		
C_{res}	Reverse Transfer Capacitance			65		
Q_g	Total Gate Charge ^③	Gate Charge $V_{GE} = 15V$ $V_{CC} = 0.5V_{CES}$ $I_C = I_{C2}$		95		nC
Q_{ge}	Gate-Emitter Charge			40		
Q_{gc}	Gate-Collector ("Miller") Charge			8		
$t_{d(on)}$	Turn-on Delay Time	Resistive Switching (25°C) $V_{GE} = 15V$ $V_{CC} = 0.8V_{CES}$ $I_C = I_{C2}$ $R_G = 10\Omega$		10		ns
t_r	Rise Time			34		
$t_{d(off)}$	Turn-off Delay Time			115		
t_f	Fall Time			125		
$t_{d(on)}$	Turn-on Delay Time	Inductive Switching (150°C) $V_{CLAMP(Peak)} = 0.66V_{CES}$ $V_{GE} = 15V$ $I_C = I_{C2}$ $R_G = 10\Omega$ $T_J = +150^\circ C$		15		ns
t_r	Rise Time			15		
$t_{d(off)}$	Turn-off Delay Time			190		
t_f	Fall Time			30		
E_{on}	Turn-on Switching Energy	$R_G = 10\Omega$ $T_J = +150^\circ C$		0.55		mJ
E_{off}	Turn-off Switching Energy			0.45		
E_{ts}	Total Switching Losses			1.0		
$t_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C) $V_{CLAMP(Peak)} = 0.66V_{CES}$ $V_{GE} = 15V$ $I_C = I_{C2}$ $R_G = 10\Omega$ $T_J = +25^\circ C$		15		ns
t_r	Rise Time			18		
$t_{d(off)}$	Turn-off Delay Time			160		
t_f	Fall Time			25		
E_{ts}	Total Switching Losses			0.60		mJ
gfe	Forward Transconductance	$V_{CE} = 20V, I_C = I_{C2}$	4			S

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			1.25	°C/W
$R_{\theta JA}$	Junction to Ambient			80	

① Repetitive Rating: Pulse width limited by maximum junction temperature.

② $I_C = I_{C2}, R_{GE} = 25\Omega, L = 200\mu H, T_J = 25^\circ C$

③ See MIL-STD-750 Method 3471

④ The maximum current is limited by lead temperature.

APT Reserves the right to change, without notice, the specifications and information contained herein.